

## 产品规格型号命名规则

## General Product Parts Numbering System

例 [example] FCC0805X106K350FT

|                    |                                                                                                                                                                                                                                                                                     |
|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>F</b><br>公司名    | FOJAN                                                                                                                                                                                                                                                                               |
| <b>CC</b><br>产品别   | 陶瓷电容器代号 Code of Ceramic Capacitor                                                                                                                                                                                                                                                   |
| <b>0805</b><br>尺寸  | 规格 Chip Size Type=L×W<br>0201=0.60×0.30mm 0402=1.00×0.50mm 0603=1.60×0.80mm<br>0805=2.00×1.25mm 1206=3.20×1.60mm 1210=3.20×2.50mm                                                                                                                                                   |
| <b>X</b><br>温度特性   | 温度特性 Dielectrics<br>COG=N, X7R=B, X5R=X, Y5V=F, X7T=T, X6S=S                                                                                                                                                                                                                        |
| <b>106</b><br>电容值  | 电容值 Capacitance<br>105=10×10 <sup>5</sup> =2200000pF 5 表示 10 <sup>s</sup><br>Two significant digits followed by no. of zero                                                                                                                                                         |
| <b>K</b><br>公差     | 容量容差 Capacitance Tolerance<br>A=±0.05pF B=±0.1pF C=±0.25pF D=±0.5pF F=±1.0% G=±2.0%<br>J=±5.0% K=±10% M=±20% Z=-20/+80%                                                                                                                                                             |
| <b>350</b><br>额定电压 | 额定电压 Rated Voltage<br>6R3=6.3V <sub>DC</sub> 100=10V <sub>DC</sub> 160=16V <sub>DC</sub> 350=35V <sub>DC</sub> 500=50V <sub>DC</sub> 101=100V <sub>DC</sub><br>201=200V <sub>DC</sub> 251=250V <sub>DC</sub> 501=500V <sub>DC</sub> 102=1000V <sub>DC</sub> 202=2000V <sub>DC</sub> |
| <b>F</b><br>厚度     | 厚度 Thickness<br>A:0.5±0.10mm B:0.60±0.10mm C:0.80±0.10mm D:0.85±0.10mm E:1.00±0.10mm<br>F:1.25±0.20mm H:1.6±0.20mm G:2.0±0.20mm M:2.5±0.30mm Z:0.3±0.03mm                                                                                                                           |
| <b>T</b><br>包装     | 包装 Packing<br>B:袋散装 B: bulk packaging in a bag T:编带 T:tape carrier packa                                                                                                                                                                                                            |
| <b>S</b><br>特殊码    | 特殊码 Specific<br>S:防断裂                                                                                                                                                                                                                                                               |

## 产品特性 Dimensions

### 产品的介质特性组别

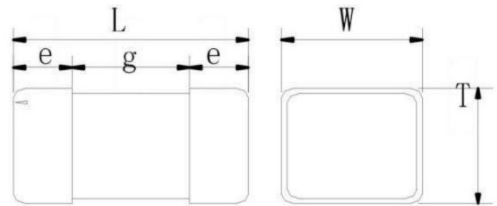
| 材质      | 工作温度范围        | 温度系数或温度特性 |
|---------|---------------|-----------|
| X5R (x) | -55°C ~ +85°C | ±15%      |

### 产品的额定值

| 容值   | 容值公差 | 额定电压  |
|------|------|-------|
| 10uF | ±10% | 35Vdc |

## 产品尺寸 Dimensions

规格： 0201 、 0402 、 0603 、 0805 、 1206 、 1210。  
Chip Size : 0201,0402,0603,0805, 1206 and 1210



| 规格<br>Type | L<br>(mm) | W<br>(mm) | e<br>(mm) | g min<br>(mm) | T<br>(mm) |   |   |   |
|------------|-----------|-----------|-----------|---------------|-----------|---|---|---|
| 0805       | 2.00±0.20 | 1.25±0.20 | 0.2~0.7   | 0.7           | 1.25±0.20 | — | — | — |

## 技术要求和测试条件

### Specification and Test Condition

#### ■ 外观 Appearance

| 类型 Dielectrics  | 技术要求 Specification                    | 测试条件 Testing Condition     |
|-----------------|---------------------------------------|----------------------------|
| COG/X7R/X5R/X6S | 无缺陷或异常<br>No defects or abnormalities | 目视检查<br>Visual inspection. |

#### ■ 尺寸 Dimensions

| 类型 Dielectrics  | 技术要求 Specification                         | 测试条件 Testing Condition               |
|-----------------|--------------------------------------------|--------------------------------------|
| COG/X7R/X5R/X6S | 在要求的范围内<br>Within the specified dimensions | 用千分尺<br>Using calipers on micrometer |

#### ■ 容量 Capacitance

| 类型 Dielectrics | 技术要求 Specification                                                                                                                                              | 测试条件 Testing Condition                                                                                                                |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| COG            | 在要求的容值容差范围内<br>Within the specified tolerance<br>A: $\pm 0.05\text{pF}$ ; B: $\pm 0.1\text{pF}$ ; C: $\pm 0.25\text{pF}$ ; D: $\pm 0.5\text{pF}$ ; J: $\pm 5\%$ | $1.0 \pm 0.2\text{Vrms}$ , $1\text{MHz} \pm 10\%$<br>( $C > 1000\text{pF}$ , $1.0 \pm 0.2\text{Vrms}$ ,<br>$1\text{KHz} \pm 10\%$ , ) |
| X7R/X5R/X6S    | 在要求的容值容差范围内<br>Within the specified tolerance<br>J: $\pm 5\%$ ; K: $\pm 10\%$ ; M: $\pm 20\%$                                                                   | $1.0 \pm 0.2\text{Vrms}$ , $1\text{KHz} \pm 10\%$<br>( $C_p > 10\mu\text{F}$ , $0.5 \pm 0.1\text{Vrms}$ ,<br>$120 \pm 24\text{Hz}$ )  |

备注:

测试温度:  $25^\circ\text{C} \pm 3^\circ\text{C}$ , 测试湿度:  $< 70\%\text{RH}$ . 针对二类介质规格需去老化处理, 条件: 电容器在  $150^\circ\text{C}$  热处理 1 小时, 放置 48h 后进行测量。

## ■ 损耗 Dissipation Factor

| 类型 Dielectrics                                                                       | 技术要求 Specification | 测试条件 Testing Condition                                                          |
|--------------------------------------------------------------------------------------|--------------------|---------------------------------------------------------------------------------|
| COG                                                                                  | $DF \leq 10.0\%$   | 25 °C<br>Cp>1000pF, 1.0±0.2Vrms, 1KHz±10%;<br>Cp≤1000pF, 0.5-5.0Vrms, 1MHz±10%; |
| X7R/X5R/X6S                                                                          | $DF \leq 10.0\%$   | 25 °C<br>Cp>10uF, 0.5±0.1Vrms, 120Hz±24Hz;<br>Cp≤10uF, 1.0±0.2Vrms, 1.0±0.1KHz; |
| 备注： 测试温度： 25°C±3°C，测试湿度： <70%RH. 针对二类介质规格需去老化处理，条件： 电容器在 150°C热处理 1 小时，放置 48h 后进行测量。 |                    |                                                                                 |

## ■ 绝缘电阻 Insulation Resistance

| 类型 Dielectrics                   | 技术要求 Specification                                                                  | 测试条件 Testing Condition                                                             |
|----------------------------------|-------------------------------------------------------------------------------------|------------------------------------------------------------------------------------|
| COG                              | $\geq 10 \text{ G } \Omega$ 或 $RC \geq 500 \text{ } \Omega \cdot \text{F}$ （以较小值为准） | $U_R \leq 500\text{V}$ U 测= $U_R$<br>$U_R > 500\text{V}$ U 测=500V<br>； 充电时间:60±5 秒 |
| X5R/X7R/X6S                      | 100.0M $\Omega$                                                                     | 温度:25°C<br>Charge Time:60±5sec<br>Temperture:25°C                                  |
| 备注： 测试温度： 25°C±3°C，测试湿度： <70%RH. |                                                                                     |                                                                                    |

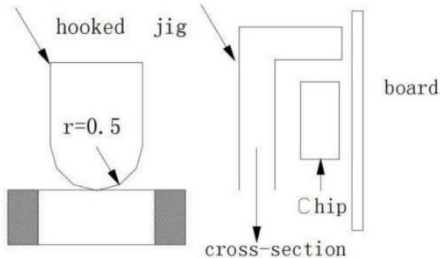
## ■ 耐电压 Dielectric Strength

| 类型Dielectrics | 额定电压范围<br>Rated voltage range | 耐电压性能测试方法Measuring Method                                                                                    |
|---------------|-------------------------------|--------------------------------------------------------------------------------------------------------------|
| COG           | $U_R \leq 50V$                | 施加额定电压的 300%,5 秒,最大电流不超过50mA<br>Force 300%Rated voltage for 5second. Max..current should not exceed 50 mA.   |
|               | $50V < U_R \leq 250V$         | 施加额定电压的 200%,5 秒,最大电流不超过50mA<br>Force 200%Rated voltage for 5second. Max..current should not exceed 50 mA.   |
|               | $250V < U_R \leq 5000V$       | 施加额定电压的 150%,5 秒,最大电流不超过50mA<br>Force 150%Rated voltage for 5second. Max..current should not exceed 50 mA.   |
|               | $500V < U_R \leq 1000V$       | 施加额定电压的 130%,5 秒,最大电流不超过50mA<br>Force 130%Rated voltage for 5second. Max..current should not exceed 50 mA.   |
| X7R/X5R/X6S   | $U_R \leq 50V$                | 施加额定电压的250%,5 秒,最大电流不超过50mA<br>Force 250%Rated voltage for 5second. Max..current should not exceed 50 mA.    |
| X7R/X5R/X6S   | $50V < U_R \leq 250V$         | 施加额定电压的200%,5 秒,最大电流不 超过50mA<br>Force 200%Rated voltage for 5second. Max..current should not exceed 50 mA.   |
|               | $250V < U_R \leq 630V$        | 施加额定电压的 150%,5 秒,最大电流不 超过50mA<br>Force 150% Rated voltage for 5second. Max..current should not exceed 50 mA. |
|               | $630V < U_R \leq 100V$        | 施加额定电压的 120%,5 秒,最大电流不 超过50mA<br>Force 120%Rated voltage for 5second. Max..current should not exceed 50 mA.  |

■ 静电容量温度特性 Temperature Coefficient of Capacitance

| 类型<br>Dielectrics | 技术要求<br>Specification                                                                                            | 测试条件<br>Testing Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |             |             |             |
|-------------------|------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-------------|-------------|
| COG               | 容量变化在 $\pm 30\text{ppm}/^\circ\text{C}$ 以内<br>Temperature coefficient within $\pm 30\text{ppm}/^\circ\text{C}$ ; | 按系列温度顺序测试电容容量<br>Measure capacitance under follow table list temperature: 在 $140\sim 150^\circ\text{C}$ 预处理 1 小时, 放置 24h 后进行测量。                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |             |             |             |
|                   |                                                                                                                  | 步骤 STEP                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | COG,X7R     | X6S         | X5R         |
|                   |                                                                                                                  | 1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | $25 \pm 2$  | $25 \pm 2$  | $25 \pm 2$  |
|                   |                                                                                                                  | 2                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | $-55 \pm 3$ | $-55 \pm 3$ | $-55 \pm 3$ |
|                   |                                                                                                                  | 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | $25 \pm 2$  | $25 \pm 2$  | $25 \pm 2$  |
| X7R/X5R           | 容量变化在 $\pm 15\%$ 以内<br>Capacitance change within $\pm 15\%$                                                      | 4                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | $125 \pm 3$ | $105 \pm 3$ | $85 \pm 3$  |
|                   |                                                                                                                  | 5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | $25 \pm 2$  | $25 \pm 2$  | $25 \pm 2$  |
|                   |                                                                                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |             |             |             |
| X6S               | 容量变化在 $\pm 22\%$ 以内<br>Capacitance change within $\pm 22\%$                                                      | <p>1) COG<br/>容量漂移的计算方法为: 用步骤 3 测量的电容容量值除以在第 1、3 和 5 步骤测量得到的误差的最大值和最小值的差。<br/>温度系数的计算以第 3 步骤测量电容容量为参考。<br/>The capacitance drift is calculated by dividing the differences between the maximum and minimum measured values in the step 1,3 and 5.<br/>The temperature coefficient is determined using the Capacitance measured in step 3 as a reference.</p> <p>2) X7R、X5R and X6S<br/>与 <math>25^\circ\text{C}</math> 时的电容容量相比较, 电容容量在温度范围内的变化在要求的范围之内。<br/>X7R、X5R and X6S<br/>The ranges of capacitance change compared within the above <math>25^\circ\text{C}</math> value over the temperature ranges shall be within the specified ranges.</p> |             |             |             |

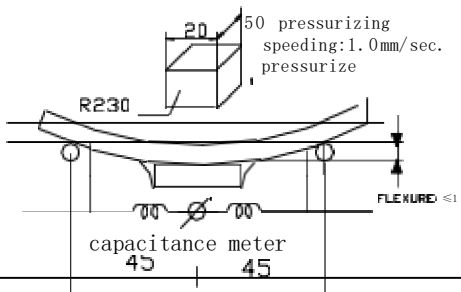
■ 附着力 Adhesion

| 类型 Dielectrics      | 技术要求 Specification                                                              | 测试条件 Testing Condition                                                                                                                                                                                                                                        |
|---------------------|---------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG/X7R/X5R/<br>X6S | 端电极无松动, 也无其它不良现象<br>No removal of the terminations or other defect shall occur. | <p>施加 5N 的压力, 并保持 <math>10 \pm 1</math> 秒<br/>The pressurizing force shall be 6N (=600g*f) and the duration of application shall be <math>10 \pm 1\text{sec}</math>.</p>  |

#### ■ 可焊性 Solder ability of Termination

| 类型 Dielectrics      | 技术要求 Specification                                                                                                          | 测试条件 Testing Condition                                                                                                                                          |
|---------------------|-----------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG/X7R/X5R/<br>X6S | 端电极挂锡面积不小于95%，针孔或粗糙面积小于 5%<br>95% min. coverage of both terminal electrodes and less than 5% have pin holes or rough spots. | 锡炉温度: 245±5℃<br>浸入时间: 2±0.5 秒<br>两侧端电极完全浸入焊锡炉<br>Solder temperature: 245±5℃<br>Dipping time: 2±1 seconds.<br>Completely soak both terminal electrodes in solder |

#### ■ 端电极结合强度 Bending

| 类型 Dielectrics | 技术要求 Specification                                                                                                   | 测试条件 Testing Condition                                                                                                                                                                                                                                                                    |
|----------------|----------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG            | 无可见损伤；容量变化小于等于±1%或±0.5pF（取较大值）<br>No remarkable visual damage Cp change within ±5.0% or ±0.5pF, whichever is larger. | 将片状电容器安装在测试夹具上，按图所示方向以 1.0mm/s 的速率施加压力，弯曲 1mm。<br>Solder the capacitor on testing substrate and put it on testing stand. The middle part of substrate shall successively be pressurized by pressuring rod at a rated of about 1.0mm/sec. Until the deflection become means of the 1.0mm.) |
| X7R/X5R/X6S    | 无可见损伤；<br>容量变化小于等于±10%（通用）或12.5%（高容）<br>No remarkable visual damage Cp change ≤ ±10%/12.5%                           |  <p>50 pressurizing<br/>speeding: 1.0mm/sec.<br/>pressurize</p> <p>R230</p> <p>capacitance meter</p> <p>45 45</p> <p>FLEXURE ≤ 1</p>                                                                  |

■ 耐焊接热 Resistance to Soldering Heat

| 类型<br>Dielectrics | 技术要求 Specification                                                                                                                                                                                                                                                                                                                                             | 测试条件 Testing Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG               | <p>无明显可见损伤</p> <p>容量变化在<math>\pm 2.5\%</math>或<math>\pm 0.25\text{pF}</math> (取较大值) 以内</p> <p>DF 满足产品初始值的要求</p> <p>IR 满足产品初始值的要求</p> <p>No remarkable visual damage</p> <p>Cp change within <math>\pm 2.5\%</math> or <math>\pm 0.25\text{pF}</math>, whichever is larger.</p> <p>DF meets initial standard value.</p> <p>IR meets initial standard value.</p> | <p>焊接温度: <math>260\pm 5^{\circ}\text{C}</math></p> <p>预热: <math>110\sim 140^{\circ}\text{C}</math> 60 秒</p> <p>浸入时间: <math>10\pm 1</math> 秒</p> <p>在室温下放置 <math>24\pm 2</math> (COG) 或 <math>48\pm 4</math> (X7R、X5R、X6S) 小时以后测量</p> <p>试验后在标准条件下恢复</p> <p>*高介电常数电容器的初始值测量</p> <p>在 <math>140\sim 150^{\circ}\text{C}</math> 进行 1 小时的热处理后在室温下放置 <math>48\pm 4</math> 小时</p> <p>测量初始值</p> <p>Soldering temperature: <math>260\pm 5^{\circ}\text{C}</math></p> <p>Preheating: <math>110\sim 140^{\circ}\text{C}</math> 60sec.</p> <p>Dipping time: <math>10\pm 1</math> seconds.</p> <p>Measurement to be made after being kept at room temperature for <math>24\pm 2</math> (COG) or <math>48\pm 4</math> (X7R, X5R, X6S) hours. Recovery for the following period under the standard condition after test.</p> <p>*Initial measurement for high dielectric constant type</p> <p>Perform a heat treatment at <math>140\sim 150^{\circ}\text{C}</math> for 1hr and let sit for <math>48\pm 4</math>hrs at room temperature. Perform the initial measurement.</p> |
| X7R/X5R/X6S       | <p>无明显可见损伤</p> <p>容量变化在<math>\pm 7.5\%</math>以内</p> <p>DF 满足产品初始值的要求</p> <p>IR 满足产品初始值的要求</p> <p>No remarkable visual damage</p> <p>Cp change within <math>\pm 7.5\%</math></p> <p>DF meets initial standard value.</p> <p>IR meets initial standard value.</p>                                                                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |

## ■ 温度快速循环 Temperature Cycle

| 类型<br>Dielectrics | 技术要求 Specification                                                                                                                                                                                                                    | 测试条件 Testing Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG               | <p>无明显可见损伤</p> <p>容量变化在<math>\pm 2.5\%</math>或 <math>\pm 0.25\text{pF}</math> (取较大值) 以内</p> <p>No remarkable visual damage</p> <p>Cp change within <math>\pm 2.5\%</math> or <math>\pm 0.25\text{pF}</math>, whichever is larger.</p> | <p>按下列步骤进行 5 次循环:</p> <p>To perform 5 cycles of the stated environment</p> <p>步骤温度<br/>Step Temperature</p> <p>下限类别温度<br/>+0/-3℃<br/>25℃</p> <p>上限类别温度<br/>+3/-0℃<br/>25℃</p>                                                                                                                                                                                                                                                                                                                                                                                                                    |
| X7R/X5R/X6S       | <p>无明显可见损伤</p> <p>容量变化在<math>\pm 15\%</math>以内</p> <p>No remarkable visual damage</p> <p>Cp change within <math>\pm 15\%</math></p>                                                                                                   | <p>在室温下放置<math>24\pm 2</math>小时 (COG), 和<math>48\pm 4</math> (X7R, X5R, X6S) 小时以后测量</p> <p>*高介电常数电容器的初始值测量在 140~150℃进行 1 小时的热处理后在室温下放置<math>48\pm 4</math> 小时测量初始值</p> <p>Measurement to be made after being kept at room temperature for <math>24\pm 2\text{hrs}</math> (COG) or <math>48\pm 4\text{hrs}</math> (X7R, X5R, X6S) at room temperature, then measure.</p> <p>*Initial measurement for high dielectric constant type</p> <p>Perform a heat treatment at 140~ 150 ℃ for 1hr and let sit for <math>48\pm 4\text{hrs}</math> at room temperature. Perform the initial measurement.</p> |

■ 耐湿负荷 Damp heat with load

| 类型<br>Dielectrics | 技术要求 Specification                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 测试条件 Testing Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG               | <p>外观无明显可见损伤</p> <p>容量变化在<math>\pm 7.5\%</math>或<math>\pm 0.75\text{pF}</math> (取较大值) 以内</p> <p><math>C_p &lt; 30\text{pF}</math>, <math>Q \geq 100 + 10/3 \cdot C_p</math></p> <p><math>C_p \geq 30\text{pF}</math>, <math>Q \geq 200</math></p> <p>IR: 大于 <math>500\text{M}\Omega</math>或 <math>5\Omega \cdot \text{F}</math>(取较小值)</p> <p>No remarkable visual damage</p> <p><math>C_p</math> change <math>\leq \pm 7.5\%</math> or <math>\pm 0.75\text{pF}</math>, whichever is larger.</p> <p><math>C_p &lt; 30\text{pF}</math>, <math>Q \geq 100 + 10/3 \cdot C_p</math></p> <p><math>R \cdot C \geq 500\text{M}\Omega</math> or <math>5\Omega \cdot \text{F}</math>, whichever is smaller</p> | <p>测试温度: <math>40 \pm 2^\circ\text{C}</math></p> <p>测试湿度: 90~95% RH</p> <p>测试电压: 额定电压 (最高电压<math>\leq 630\text{V}</math>)</p> <p>测试电流: 最大<math>\leq 50\text{mA}</math></p> <p>测试时间: <math>500 \pm 24\text{hrs}</math></p> <p>在室温下放置 <math>24 \pm 2</math> (COG) 或 <math>48 \pm 4</math>(X7R、X5R、X6S) 小时以后测量</p> <p>Test temperature: <math>40 \pm 2^\circ\text{C}</math></p> <p>Humidity: 90~95% RH</p> <p>Voltage: 100% UR</p> <p>Electric current: <math>\leq 50\text{mA}</math></p> <p>Testing time: <math>500 \pm 24\text{hrs}</math></p> <p>Measurement to be made after being kept at room temperature for <math>24 \pm 2\text{hrs}</math> (COG) or <math>48 \pm 4\text{hrs}</math> (X7R, X5R, X6S)</p> |
| X7R/X5R/X6S       | <p>外观无明显可见损伤</p> <p>容量变化在<math>\pm 12.5\%</math>以内</p> <p>DF 为初始值的 2 倍以下</p> <p>IR: 大于 <math>500\text{M}\Omega</math>或 <math>5\Omega \cdot \text{F}</math>(取较小值)</p> <p>No remarkable visual damage</p> <p><math>C_p</math> change <math>\leq \pm 12.5\%</math></p> <p>DF :Not more than 2 times of initial value</p> <p><math>R \cdot C \geq 500\text{M}\Omega</math> or <math>5\Omega \cdot \text{F}</math>, whichever is smaller</p>                                                                                                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |

备注: 该项可靠性试验仅适用于常规产品, 不适用于中高压产品。

■ 耐久性 Life Test

| 类型<br>Dielectrics               | 技术要求 Specification                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 测试条件 Testing Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COG                             | <p>外观无明显可见损伤</p> <p>容量变化在<math>\pm 3\%</math>或<math>\pm 0.3\text{pF}</math> (取较大值) 以内</p> <p>容量在 <math>30\text{pF}</math> 以上, <math>Q \geq 350</math></p> <p>容量在<math>10\text{pF}</math> 以上且小于<math>30\text{pF}</math>, <math>Q \geq 275 + (2.5 * \text{Cp})</math></p> <p>容量小于 <math>10\text{pF}</math>, <math>Q \geq 200 + 10 * \text{Cp}</math></p> <p>IR: 大于 <math>1000\text{M}\Omega</math> 或 <math>5\Omega \cdot \text{F}</math> (取较小值)</p> <p>No remarkable visual damage</p> <p>Cp change <math>\leq \pm 3\%</math> or <math>\pm 0.3\text{pF}</math>, whichever is larger.</p> <p><math>Q \geq 350</math> (<math>\text{Cp} \geq 30\text{pF}</math>)</p> <p><math>Q \geq 275 + (2.5 * \text{Cp})</math> (<math>10\text{pF} \leq \text{Cp} &lt; 30\text{pF}</math>)</p> <p><math>Q \geq 200 + 10 * \text{Cp}</math> (<math>\text{Cp} &lt; 10\text{pF}</math>)</p> <p><math>R * C \geq 1000\text{M}\Omega</math> or <math>5\Omega \cdot \text{F}</math>, whichever is smaller</p> | <p>测试温度: 上限类别温度<math>\pm 3^\circ\text{C}</math></p> <p>测试电压: <math>100\%U_R</math></p> <p>测试电流: 最大<math>\leq 50\text{mA}</math></p> <p>测试时间: <math>1000 \pm 12\text{hrs}</math></p> <p>在室温下放置 <math>24 \pm 2</math> (COG) 或 <math>48 \pm 4</math> (X7R、X5R、Y5V、X7T、X6S) 小时以后测量</p> <p>Test temperature:<br/>Max. Operating Temp. <math>\pm 3^\circ\text{C}</math></p> <p>Voltage: <math>100\%U_R</math></p> <p>Electric current: <math>\leq 50\text{mA}</math></p> <p>voltage Testing time: <math>1000 \pm 12\text{hrs}</math></p> <p>Measurement to be made after being kept at room temperature for <math>24 \pm 2\text{hrs}</math> (COG) or <math>48 \pm 4\text{hrs}</math> (X7R, X5R, X6S)</p> |
| X7R/X5R/X6S                     | <p>外观无明显可见损伤</p> <p>容量变化在<math>\pm 15\%</math>以内</p> <p>DF 为初始值的 2 倍以下</p> <p>IR: X7R <math>\geq 1\text{G}\Omega</math> 或 <math>R.C \geq 10\text{S}</math><br/>X5R: <math>\geq 1\text{G}\Omega</math> 或 <math>R.C \geq 50\text{S}</math> (以较小值为准)</p> <p>No remarkable visual damage Cp change <math>\leq \pm 15\%</math></p> <p>DF: Not more than 2 times of initial value</p> <p>IR: X7R <math>\geq 1\text{G}\Omega</math> or <math>R.C \geq 10\text{S}</math>; X5R: <math>\geq 1\text{G}\Omega</math> or <math>R.C \geq 50\text{S}</math>, whichever is smaller</p>                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 备注: 该项可靠性试验仅适用于常规产品, 不适用于中高压产品。 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |

## 产品包装 Packing

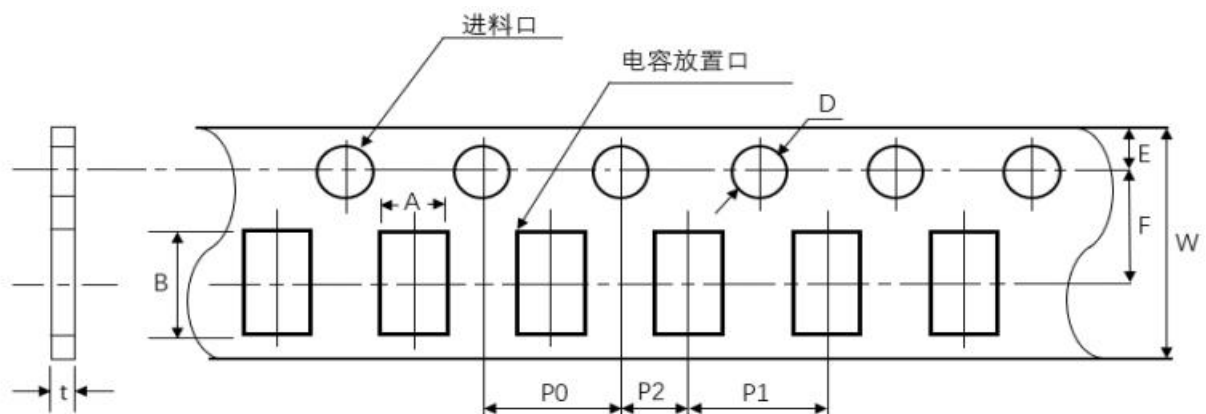
### ■ 袋式散装 Bulk Packing

10000 个/袋或按客户要求。Standard packing 10Kpcs/bag; others are according to customer request.

### ■ 编带式包装 Tape Packing

| 规格<br>Type | 尺寸 Size (mm) |      |        | 编带数量(个/盘 pcs/reel) |                 |
|------------|--------------|------|--------|--------------------|-----------------|
|            | 长度L          | 宽度W  | 厚度T    | 纸带Paper Tape       | 塑料带Plastic Tape |
| 0201       | 0.6          | 0.3  | 0.3    | 15,000             | N/A             |
| 0402       | 1.0          | 0.5  | 0.5    | 10,000             | N/A             |
| 0603       | 1.6          | 0.8  | 0.8    | 4,000              | N/A             |
| 0805       | 2.0          | 1.25 | ≤ 0.85 | 4,000              | N/A             |
|            |              |      | > 0.85 | N/A                | 2,000 (或3,000)  |
| 1206       | 3.2          | 1.6  | ≤ 0.85 | 4,000              | N/A             |
|            |              |      | > 0.85 | N/A                | 2,000 (或3,000)  |
| 1210       | 3.2          | 2.5  | ≤ 1.25 | N/A                | 2,000           |
|            |              |      | > 1.25 | N/A                | 2,000           |

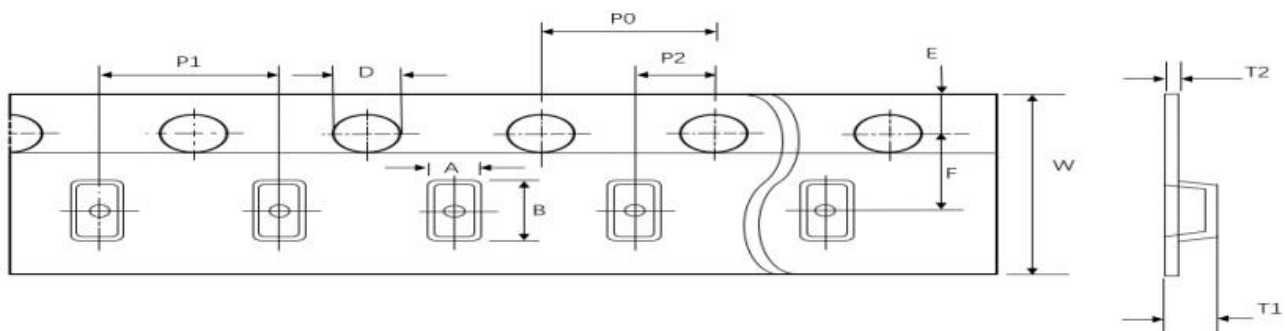
### ■ 纸带尺寸 Dimensions of Packing Paper



|    | 01005<br>(0402)                    | 0201<br>(0603)  | 0402<br>(1005)  | 0603<br>(1608)           | 0805<br>(2012)  | 1206<br>(3216)  |
|----|------------------------------------|-----------------|-----------------|--------------------------|-----------------|-----------------|
| P1 | $2.00 \pm 0.05$ ( $1.0 \pm 0.05$ ) |                 |                 | $4.00 \pm 0.10$          |                 |                 |
| P0 | $4.00 \pm 0.10$                    |                 |                 | $4.00 \pm 0.10$          |                 |                 |
| P2 | $2.00 \pm 0.05$                    |                 |                 | $2.00 \pm 0.05$          |                 |                 |
| A  | $0.25 \pm 0.02$                    | $0.38 \pm 0.03$ | $0.62 \pm 0.05$ | $1.00 \pm 0.01$          | $1.55 \pm 0.10$ | $2.05 \pm 0.10$ |
| B  | $0.46 \pm 0.02$                    | $0.68 \pm 0.03$ | $1.12 \pm 0.05$ | $1.90 \pm 0.10$          | $2.30 \pm 0.10$ | $3.60 \pm 0.10$ |
| W  | $8.00 \pm 0.30$                    |                 |                 | $8.00 \pm 0.30$          |                 |                 |
| E  | $1.75 \pm 0.10$                    |                 |                 | $1.75 \pm 0.10$          |                 |                 |
| F  | $3.50 \pm 0.05$                    |                 |                 | $3.50 \pm 0.05$          |                 |                 |
| D  | $\phi 1.50 + 0.10 / - 0.03$        |                 |                 | $\phi 1.50 + 0.10 / - 0$ |                 |                 |
| t  | $0.25 \pm 0.02$                    | $0.35 \pm 0.03$ | $0.60 \pm 0.05$ | 1.1Below                 |                 |                 |

单位unit:毫米mm

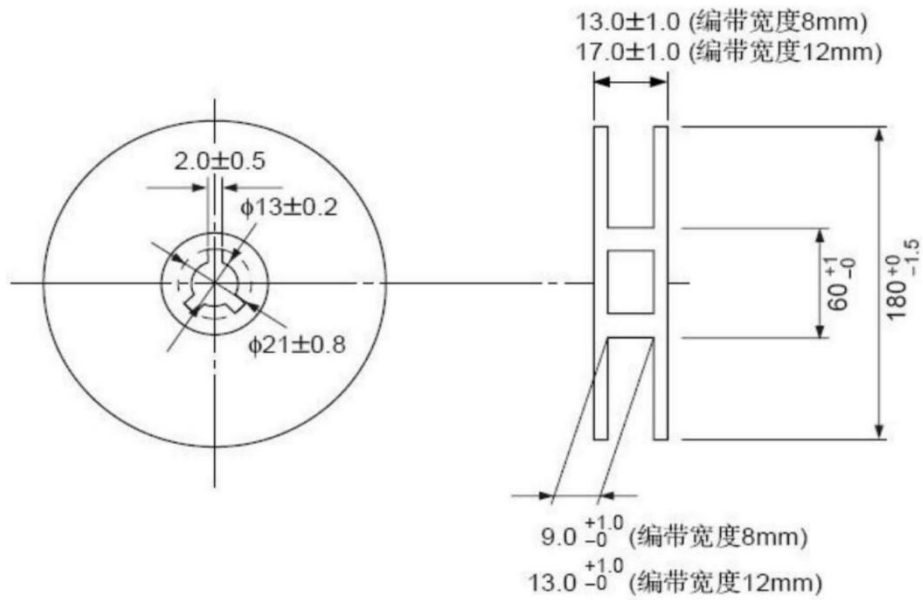
#### 塑料带尺寸 Dimensions of Embossed Packing



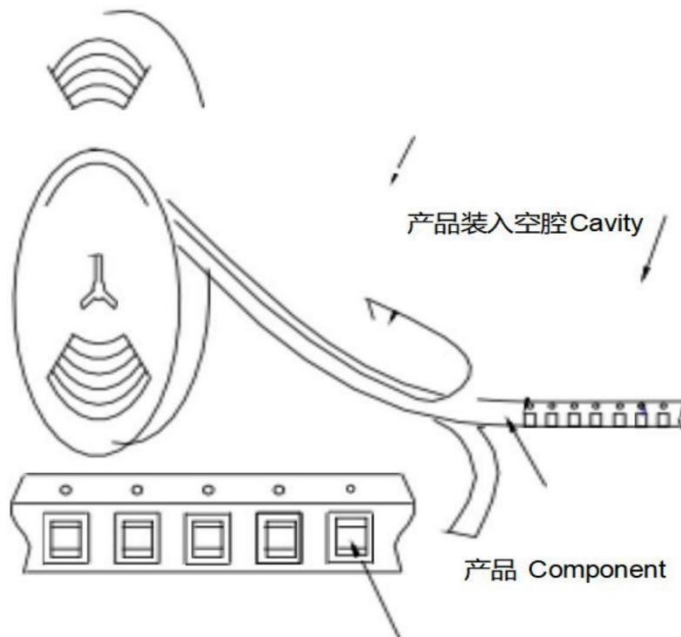
|    | 0603<br>(1608)       | 0805<br>(2012)       | 1206<br>(3216)       | 1210<br>(3225)       |
|----|----------------------|----------------------|----------------------|----------------------|
| P1 | $4 \pm 0.1$          | $4 \pm 0.1$          | $4 \pm 0.1$          | $4 \pm 0.1$          |
| P0 | $4 \pm 0.1$          | $4 \pm 0.1$          | $4 \pm 0.1$          | $4 \pm 0.1$          |
| P2 | $2 \pm 0.05$         | $2 \pm 0.05$         | $2 \pm 0.05$         | $2 \pm 0.05$         |
| A  | $12 \pm 0.2$         | $1.45 \pm 0.2$       | $1.9 \pm 0.2$        | $2.8 \pm 0.2$        |
| B  | $2.0 \pm 0.2$        | $2.3 \pm 0.2$        | $3.5 \pm 0.2$        | $3.6 \pm 0.2$        |
| W  | $8 \pm 0.3$          | $8 \pm 0.2$          | $8 \pm 0.2$          | $8 \pm 0.2$          |
| E  | $1.75 \pm 0.1$       | $1.75 \pm 0.1$       | $1.75 \pm 0.1$       | $1.75 \pm 0.1$       |
| F  | $3.5 \pm 0.05$       | $3.5 \pm 0.05$       | $3.5 \pm 0.05$       | $3.5 \pm 0.05$       |
| D  | $1.5 (+0.1 / - 0.0)$ | $1.5 (+0.1 / - 0.0)$ | $1.5 (+0.1 / - 0.0)$ | $1.5 (+0.1 / - 0.0)$ |
| T1 | 1.4 max              | 2.5 max.             | 2.5 max.             | 2.5 max.             |
| T2 | $0.25 \pm 0.1$       | $0.305 \pm 0.1$      | $0.30 \pm 0.1$       | $0.30 \pm 0.1$       |

单位unit:毫米mm

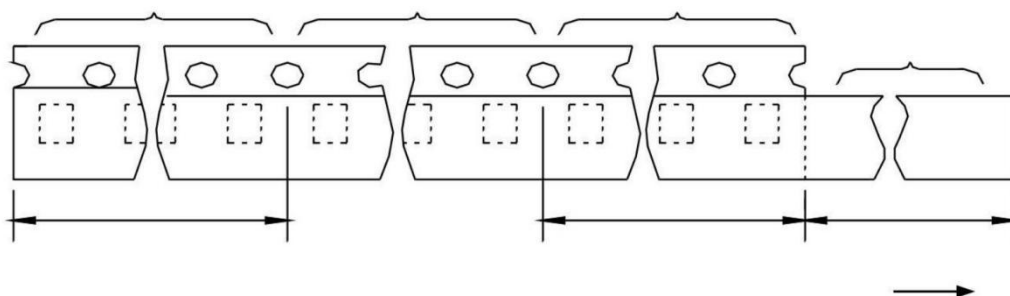
■ 编带盘尺寸 Dimensions of Reel



## ■ 编带方式 Taping Figure



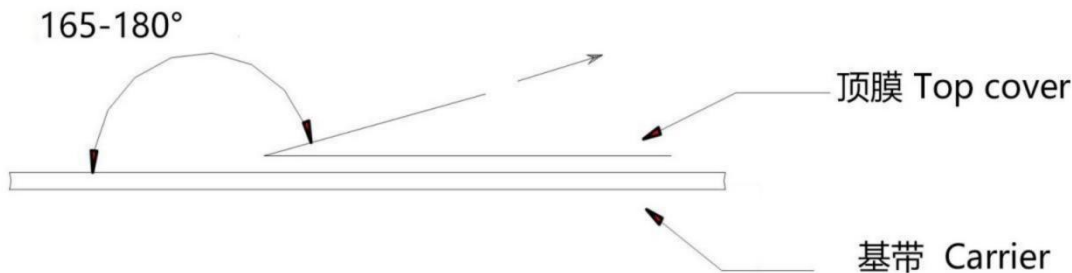
空白部分 Empty section    产品装入部分 Chip insertion section    空白部分 Empty section



## ■ 编带方法 Taping Method

- 1 包装电容器的编带是顺时针卷绕的，由上往下的方向拉出编带时，传送孔处于编带的右侧。
  - 2 在编带的前端，至少留出 5 个间距的引出带。
  - 3 在编带时，必须上图留出引带部分或空白部分。
  - 4 在盘带的安装中的产品装错的数量每盘必须小于表示数量的 0.1% 或 1 个为限，不连续发生错误。
  - 5 上胶带和下胶带不应超出编带的边缘，不能挡住传送孔。
  - 6 传送孔的累计误差为 10 个间距：±0.3 毫米以内。
  - 7 上胶带的剥离力矩应在 0.1 至 0.6 牛顿以内，其方向如下图所示。
- ①Tapes for capacitors are wound clockwise. The sprocket holes are to the right as the tape is pulled toward the user.
- ②The top tape and base tape are not attached at the end of the tape for a minimum of 5 pitches.
- ③Part of the leader and part of the empty tape shall be attached to the end of the tape as follows.
- ④Missing capacitors number within 0.1% of the number per reel or 1pc, whichever is greater, and are not continuous.

- ⑤ The top tape and bottom tape shall not protrude beyond the edges of the tape and shall not cover sprocket holes.
- ⑥ Cumulative tolerance of sprocket holes, 10 pitches:  $\pm 0.3\text{mm}$ .
- ⑦ Peeling off force: 0.1 to 0.6N in the direction shown down.



#### ■ 产品标签 Reel Label



#### 标签内容 The Contents of Label

(1) FCC    1206    B    104    K    500    D    T        
①            ②            ③            ④            ⑤            ⑥            ⑦            ⑧            ⑨

① 陶瓷电容器代号 Code of Ceramic Capacitor

② 尺寸 chip size, ③ 温度特性 dielectrics, ④ 容量 capacitance, ⑤ 容量容差 tolerance,

⑥ 额定电压 rated voltage, ⑦ 厚度 thickness, ⑧ 包装 packing ⑨ 特殊码

(2) 产品批号 Lot: K20211170131

(3) 数量 Qty: 4000pcs

(4) RoHS: GREEN PARTS 绿色物料

- 外包装 Package
- 包装箱 Carton
- 包装箱尺寸 Carton Size

| L      | W      | H      |
|--------|--------|--------|
| 41.0cm | 38.5cm | 20.2cm |

- 数量: 240Kpcs /箱 The Quantity: 240Kpcs /one carton

1 内包装盒=40,000PCS                      1 INNER BOX=40,000PCS  
 1 包装箱 =40,000PCS × 6 包装盒=240,000PCS              1 CARTON=40,000PCS × 6 INNER BOX  
 =240,000PCS RoHS 标识(根据客户要求张贴)              according to customer request

- 内包装盒 Inner Box
- 包装盒尺寸 Size

| L      | W     | H    |
|--------|-------|------|
| 18.5cm | 6.5cm | 19cm |

- 数量: 40Kpcs /盒

1 盘=4000PCS                      1 REEL=4,000PCS  
 1 包装盒=4,000PCS × 10 盘 =40,000PCS              1 INNER BOX=4,000PCS × 10REEL =40,000PC

## MLCC 使用注意事项

### Precautions on the use of MLCC

#### ■ 电路板设计 PCB Design

##### ■ 电路板图案设计 Design of Land-patterns

下面图和表格给出了部分推荐的设计图案，可以防止安装时焊锡量过多。

同时也给出了不正确的图案。

The following diagrams and tables show some examples recommended patterns to prevent excessive solder amounts (larger fillets which above the component end terminations)

Examples of improper pattern designs are also shown.

电路板设计推荐图案尺寸：|

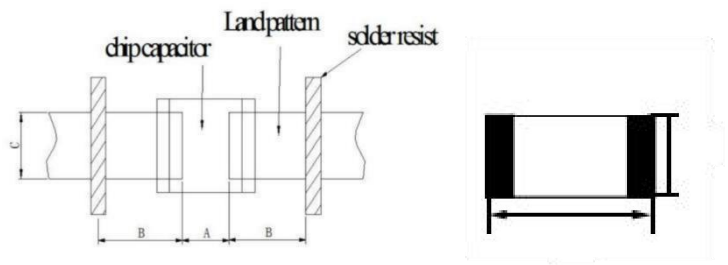
Recommended land dimensions for a typical chip capacitor land patterns for PCBs

波峰焊接时推荐设计的尺寸（单位：mm）：

Recommended land dimensions for wave-soldering (unit: mm)

回流焊接时推荐设计的尺寸（单位：mm）

| 规格 SIZE |   | 0603    | 0805    | 1206    |
|---------|---|---------|---------|---------|
| 尺寸      | L | 1.6     | 2.0     | 3.2     |
|         | W | 0.8     | 1.25    | 1.6     |
| A       |   | 0.8~1.0 | 1.0~1.4 | 1.8~2.5 |
| B       |   | 0.5~0.8 | 0.8~1.5 | 0.8~1.7 |
| C       |   | 0.6~0.8 | 0.9~1.2 | 1.2~1.6 |



Recommended land dimensions for reflow-soldering (unit: mm)

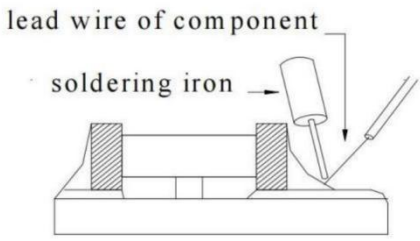
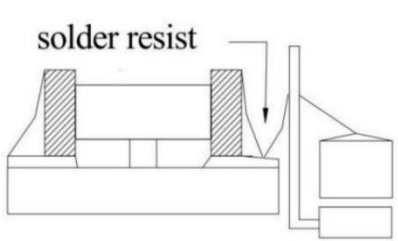
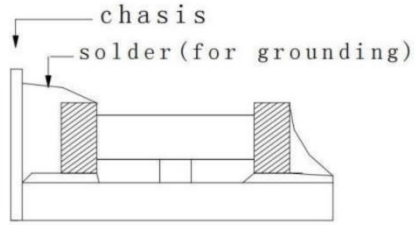
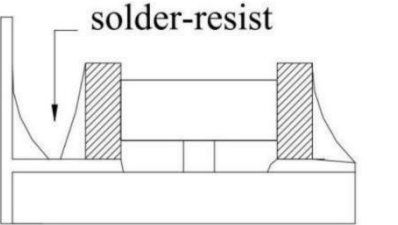
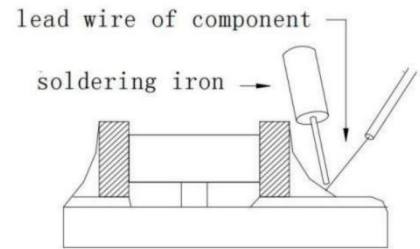
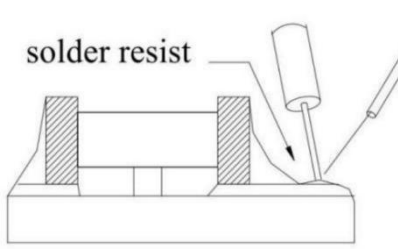
| 规格 SIZE |   | 0201      | 0402      | 0603    | 0805    | 1206    | 1210    |
|---------|---|-----------|-----------|---------|---------|---------|---------|
| 尺寸      | L | 0.6       | 1.0       | 1.6     | 2.00    | 3.2     | 3.2     |
|         | W | 0.3       | 0.5       | 0.8     | 1.25    | 1.6     | 2.5     |
| A       |   | 0.20~0.25 | 0.35~0.45 | 0.6~0.8 | 0.8~1.2 | 1.8~2.5 | 1.8~2.5 |
| B       |   | 0.20~0.30 | 0.40~0.50 | 0.6~0.8 | 0.8~1.2 | 1.0~1.5 | 1.0~1.5 |
| C       |   | 0.25~0.35 | 0.45~0.55 | 0.6~0.8 | 0.9~1.6 | 1.2~2.0 | 1.6~3.2 |

过量的焊锡会影响产品抵抗机械应力的能力，因此在设计图案时应引起注意。

Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.

在应用中一些焊接好与坏的情况：

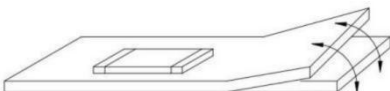
Examples of good and bad solder application

| 项目 Item                                                                        | 不推荐结构 Not recommended                                                               | 推荐结构 Recommended                                                                     |
|--------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| 片状元件和带引线的元件的混合焊接<br>Mixed mounting of SMD and leaded component                 |    |    |
| 靠近底座的焊接<br>Component placement close to the chassis                            |    |    |
| 在片状元件附近带引线元件的焊接<br>Hand-soldering of leaded components near mounted components |  |  |

#### ■ 图案结构 Pattern configurations

下面是电容器安装好与坏的例子。选择贴装位置，应尽可能减小电路板在弯曲时受到的机械应力。

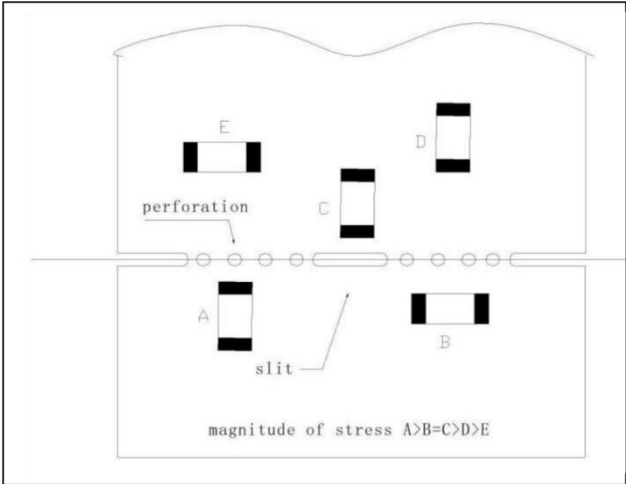
The following are examples of good and bad capacitor layout, SMD capacitors should be located to minimize any possible mechanical stresses from board warp or deflection.

|                                  | 不推荐结构 Not recommended                                                               | 推荐结构 Recommended                                                                     |
|----------------------------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| 电路板弯曲<br>Deflection of the board |  |  |

对于电路板分拨的电容器，在分拨时受到的机械应力大小与电容器的安装有关。下面推荐了一些好的设计。

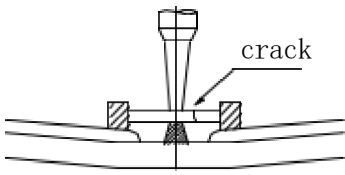
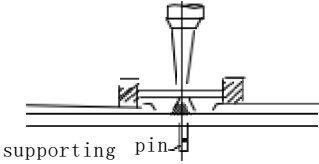
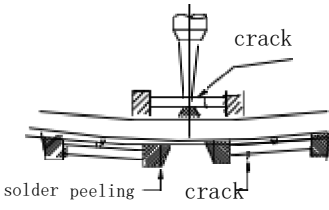
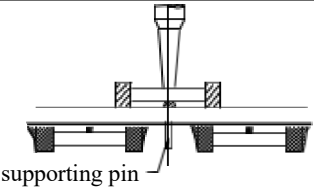
To layout the capacitors for the breakaway PC board, it should be noted that the amount of mechanical stresses given depending on capacitor layout. The example below shows recommendations for better design.

在沿着分拨线分拨电路板时，对产品施加的机械应力与使用的方法关系很大。分折电路板时片状元件受到的疲劳按照如下顺序增大：分折、剪切、V 型槽、穿孔。因此，贴装时应该考虑电路板的分拨过程。  
When breaking PC boards along their perforations, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, silt, -grooving, and perforation. Thus, any ideal SMD capacitor layout must also consider the PCB splitting procedure.



■ 自动贴装注意事项 Considerations for automatic placement  
■ placement 贴装机的调整 Adjustment of mounting machine

- ①.产品在电路板贴装时，不应该受到过大的冲击。
- ②.必须定期对吸头和定位爪进行检查、维修和更换
- ①.Excessive impact load should not be imposed on the capacitors when mounting the PC boards.
- ②.The maintenance and inspection of the mounters should be conducted periodically.

|                               | 不推荐结构 Not recommended                                                               | 推荐结构 Recommended                                                                      |
|-------------------------------|-------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| 单面贴装<br>Single-sided mounting |  |  |
| 双面贴装<br>Double-sided mounting |  |  |

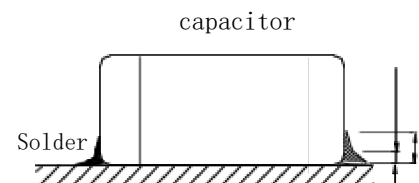
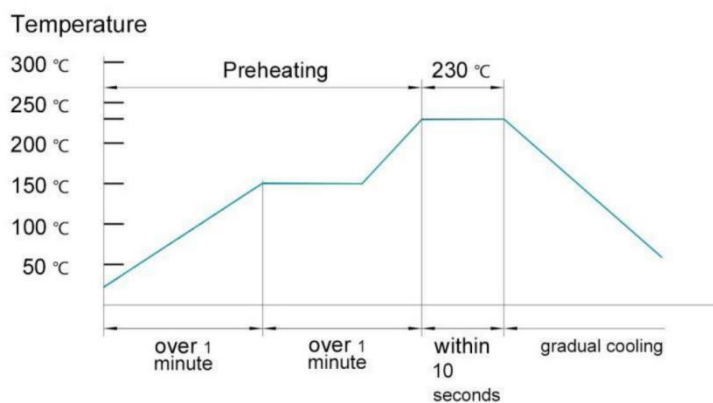
## ■ 推荐焊接曲线 Recommended soldering profile

### ■ 说明

- ①.产品推荐使用回流焊接工艺;
- ②.大尺寸产品适用于回流焊接工艺
- ①.flow Soldering is recommended;
- ②.flow soldering is suitable for bigger size MLCC

## ■ 锡铅焊接曲线 Recommended Sn&Pb soldering profile

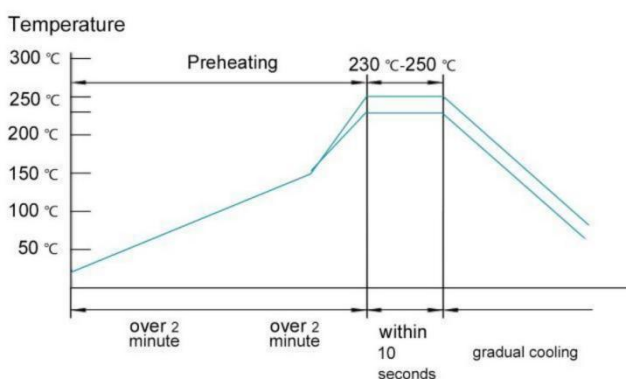
### 回流焊 Reflow soldering



### 注意 Caution

- ①.理想状况的焊锡高度为电容器厚度的 1/3 ~ 1/2 , 如右图所示:
- ②.过长的焊接时间会影响端头的可焊性, 焊接时间尽可能保持与推荐时间一致。
- ①.The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the capacitor, as shown below:
- ②.Because excessive dwell times can detrimentally affect solder ability, soldering duration should be kept as close to recommended times as possible.

### 波峰焊 Wave solder profile



注意 Caution

- ①.确保电容器充分预热。
  - ②.产品预热和焊接温度差不超过 100~ 130℃。
  - ③.焊接后尽可能慢速冷却。
- ①.Make sure the capacitors are preheated sufficiently.
- ②.The temperature difference between the capacitor and melted solder should not be greater than 100 to 130℃.
- ③.Cooling after soldering should be gradual as possible.

手工焊接 Hand soldering

条件:

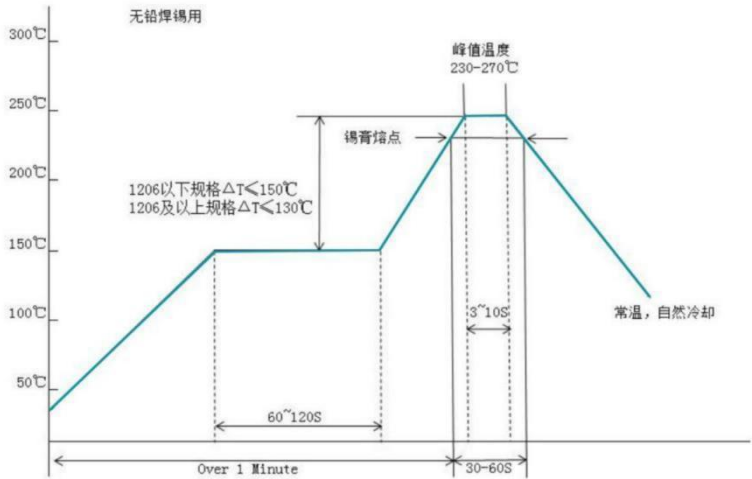
| 预热                                | 烙铁头温度   | 烙铁功率   | 烙铁头直径  | 焊接时间             | 锡膏量                     | 限制条件            |
|-----------------------------------|---------|--------|--------|------------------|-------------------------|-----------------|
| $\Delta \leq 130^{\circ}\text{C}$ | 最高 350℃ | 最大 20w | 建议 1mm | $\leq 3\text{S}$ | $\leq \frac{1}{2}$ 芯片厚度 | 请勿使用烙铁头直接接触陶瓷原件 |

注意 Caution

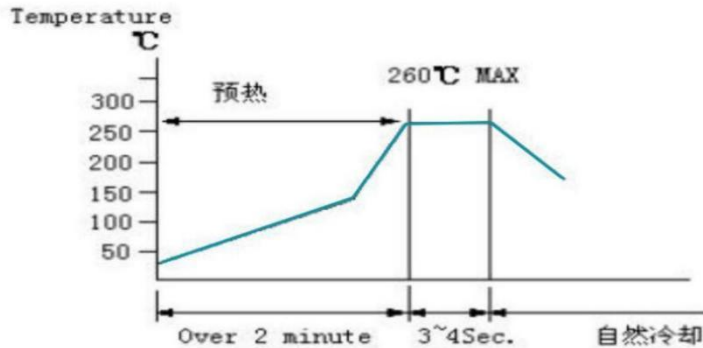
- ①.用尖端最大直径 1.0mm 功率 20W 的焊接烙铁。
  - ②.焊接烙铁不要直接接触产品。
- ①.Use a 20w soldering iron with a maximum tip diameter of 1.0mm.
- ②.The soldering iron should not directly touch the capacitor.

■ 无铅焊接曲线 Recommended Pb-Free soldering profilee

回流焊 Reflow solderin



## 波峰焊 Wave solder profile



## 分拨电路板 Handling

Breakaway PC boards (splitting along perforations)

①.在电容器或其它贴装后，必须注意因电路板弯曲或变形带来的应力。

②.分拨电路板时必须使用专用的夹具，不可以用手拨断。

① .When splitting the PC board after mounting capacitors and other components, care is required so as not to give any stresses of deflection or twisting to the board.

②.Board separation should not be done manually, but by using the appropriate devices.

## 保存 Storage

①.在下列环境中保存产品：温度 5~40°C；湿度 ≤70% RH

②.产品自生产之日保存期为一年，产品使用之前请勿拆开编带。

③.编带拆开后，产品应在三个月内使用。

④.高介电常数电容器 (X7R,X5R,Y5V、X7T、X6S) 的容值随时间会逐渐减小，所以在电路设计时应充分考虑这一现象。容值减小的电容器在 150°C热处理 1 小时后容值会恢复到初始值。

①. Keep the storage environment conditions as following: Temperature: 5~40°C； Humidity: ≤70% RH

②. Don't open the tape until the parts are to be used, and store them within one year since the date printed on the reel.

③. Use the chips within 3 months after the tape is opened.

④ . The capacitance value of high dielectric constant capacitors (X7R,X5R,Y5V、X7T、X6S) will gradually decrease with the passage of time, so this should be taken into consideration in the circuit design. If such a capacitance reduction occurs, a heat treatment of 150°C for 1 hour will return the capacitance to its initial level.